

More information on this product can be found at: http://bit.ly/SH570R6
更多本產品資訊, 請查閱: http://bit.ly/SH570R6
Weitere Informationen zu diesem Produkt finden Sie unter: http://bit.ly/SH570R6
Pour plus d'informations sur ce produit, visitez: http://bit.ly/SH570R6

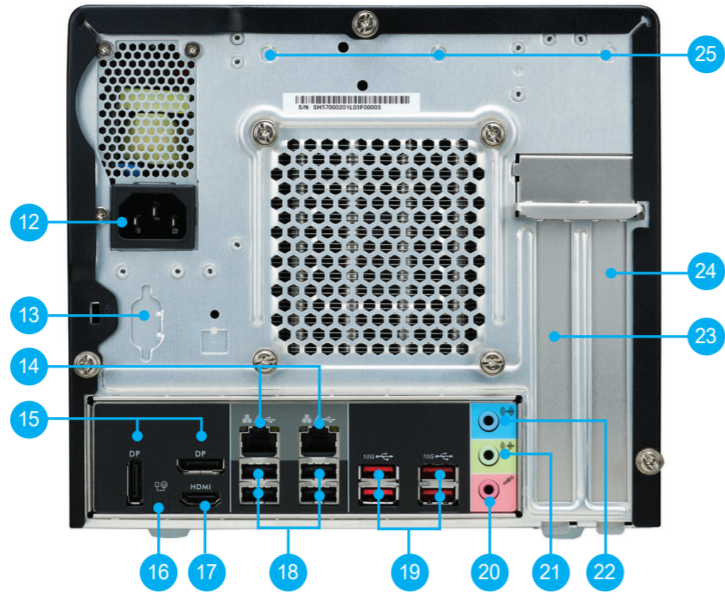
Puede encontrar más información sobre este producto en: http://bit.ly/SH570R6
本製品の詳細な情報については、次のURLより確認頂けます。http://bit.ly/SH570R6
Для получения дополнительной информации об этом продукте перейдите по ссылке: http://bit.ly/SH570R6
更多本产品信息, 请访问: http://bit.ly/SH570R6

Product Overview

產品外觀 \ Produktübersicht \ Présentation du produit \ Resumen del producto \ 製品概要 \ Обзор продукта \ 产品外观



- 1. 5.25" Bay
2. 3.5" Bay
3. ODD eject button
4. 3.5" HDD bay cover button
5. Hard disk drive LED
6. Power LED
7. Power button
8. USB 3.2 Gen1 Type-A ports
9. MIC-in
10. Headphones
11. USB 3.2 Gen1 Type-C port



- 12. AC power socket
13. Serial port (optional)
14. LAN ports
15. DisplayPort
16. Clear CMOS & Power Button & +5V
17. HDMI 2.0 port
18. USB 2.0 ports
19. USB 3.2 Gen2 Type-A ports
20. Microphone jack
21. Front speaker out (L/R) port
22. Line-in port
23. PCIe x16 slot
24. PCIe x4 slot
25. Perforation for optional WLAN

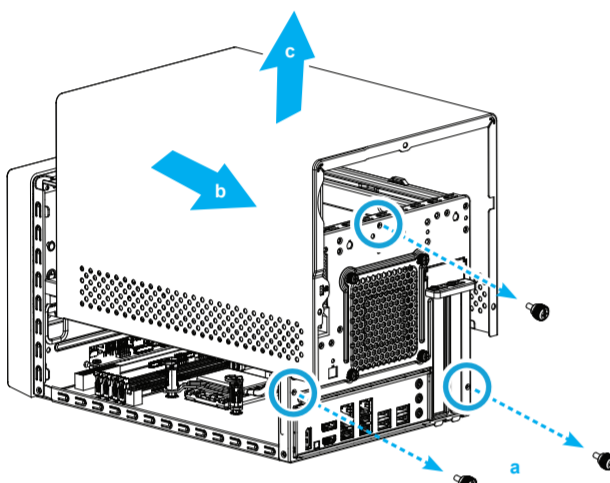
Hardware Installation

硬體安裝 \ Hardware Installation \ Installation du matériel \ Instalación de hardware \ ハードウェアのインストール \ Установка оборудования \ 硬件安装

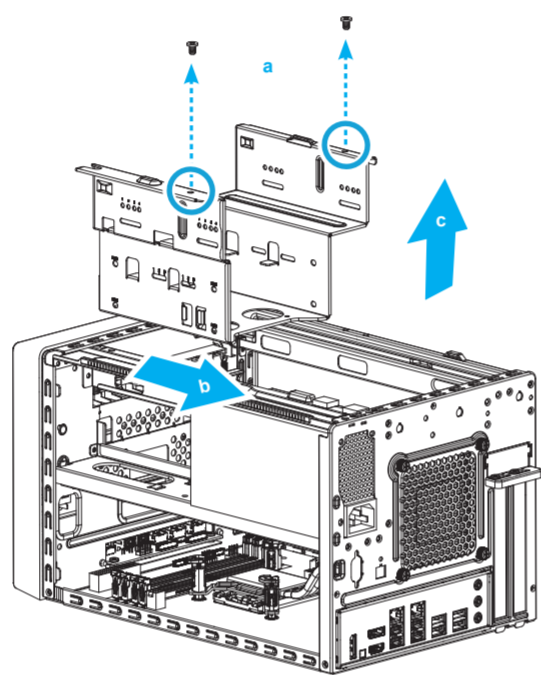
A. Begin Installation

For safety reasons, please ensure that the power cord is disconnected before opening the case.

- 1. Unscrew 3 thumbscrews of the chassis cover.
2. Slide the cover backwards and upwards.



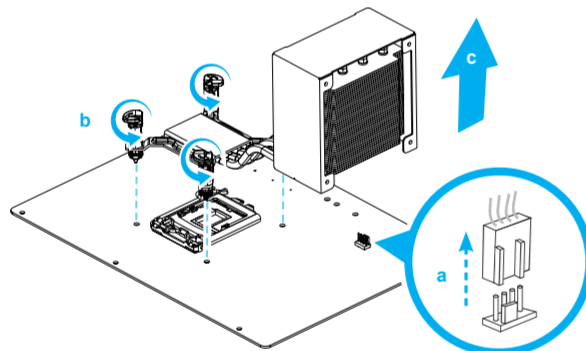
3. Unfasten the rack mount screws and remove the rack.



The product's colour and specifications may vary from the actually shipping product.

B. CPU and ICE Module Installation

- 1. Unfasten the ICE fan thumbscrews on the back of the chassis.
2. Unfasten the four ICE module attachment push-pins and unplug the fan connector.

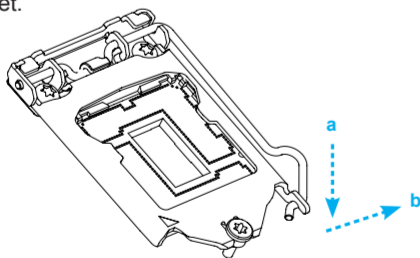


3. Remove the ICE module from the chassis and put it aside.

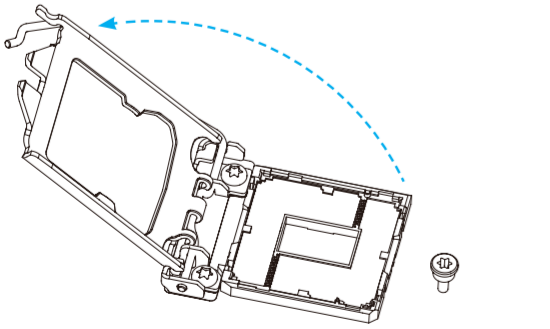
This CPU socket is fragile and can easily be damaged. Always use extreme care when installing a CPU and limit the number of times you remove or change the CPU. Before installing the CPU, make sure to turn off the computer and unplug the power cord from the power outlet to prevent damage of the CPU.

Follow the steps below to correctly install the CPU into the motherboard CPU socket.

- 4. Unlock and raise the socket lever.

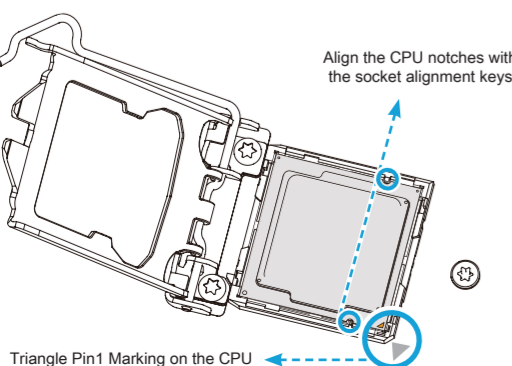


- 5. Lift the metal load plate off the CPU socket.



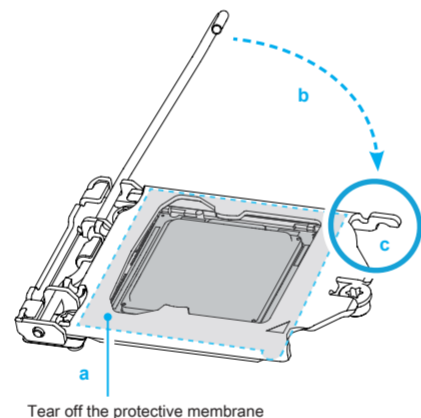
DO NOT touch the socket contacts. To protect the CPU socket, always use the protective socket cover when the CPU is not installed.

- 6. Please orientate the CPU correctly and align the CPU notches with the socket alignment keys. Make sure the CPU sits perfectly horizontal, then push it gently into the socket.

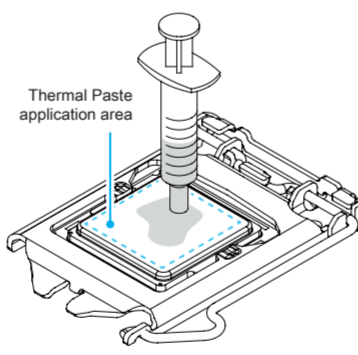


Please be aware of the CPU orientation, DO NOT force the CPU into the socket to avoid bending of pins on the socket and damage of CPU!

- 7. Tear off the protective membrane from the metal load plate. Close the metal load plate, lower the CPU socket lever and lock in place.



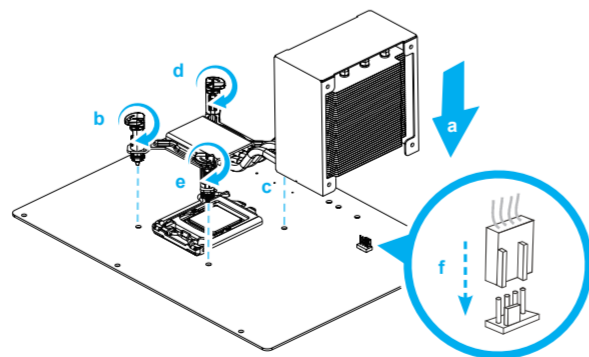
- 8. Spread thermal paste evenly on the CPU surface.



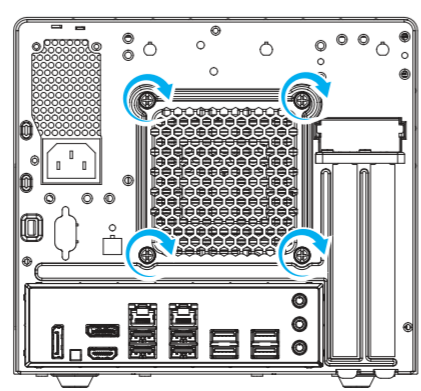
Please do not apply excess amount of thermal paste.

- 9. Screw the ICE module to the motherboard. Note to press down on the opposite diagonal corner while tightening each push-pin.

- 10. Connect the fan.



- 11. Tighten the Smart Fan to the chassis with the four thumbscrews.



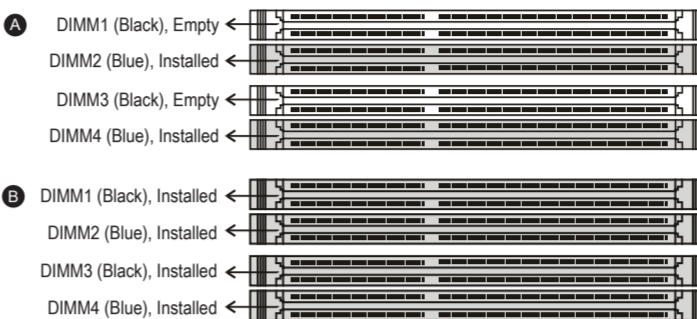
C. Memory Module Installation

Guidelines for Memory Configuration
Before installing DIMMs, read and follow these guidelines for memory configuration.

Make sure that the motherboard supports the memory. It is recommended that memory of the same capacity, brand, speed, and chips is used. (Go to Shuttle's website for the latest memory support list). Memory modules have a foolproof design. A memory module can be installed in only one direction. If you are unable to insert the module, reverse direction.

Population rules of dual channel memory modules

In Dual-Channel mode, the memory modules can transmit and receive data with two data bus lines simultaneously. Enabling Dual-Channel mode can enhance system performance. The following illustrations explain the population rules for Dual-Channel mode.

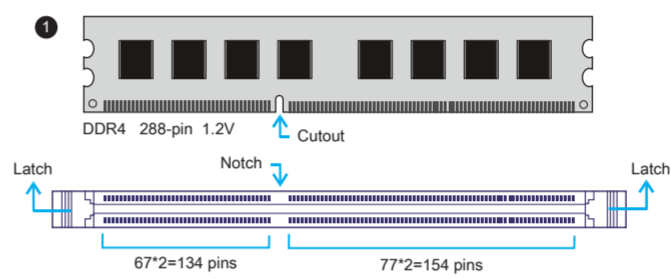


Installing memory modules

DDR4 and DDR3/DDR2 DIMMs are not compatible to one another or other DDR DIMMs. Be sure to install DDR4 DIMMs on this motherboard only. Follow the steps below to correctly install your memory modules in the memory sockets.

- 1. Unlock the DIMM latch.
2. Align the memory module's cutout with the notch of the DIMM slot. Slide the memory module into the DIMM slot.

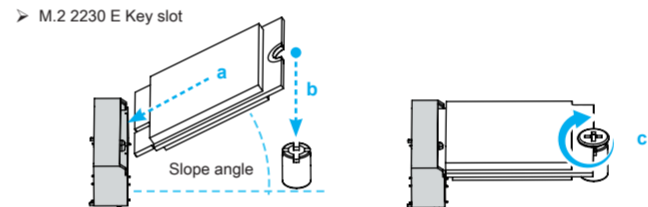
A DDR4 memory module has a cutout, so it only fits in one direction.



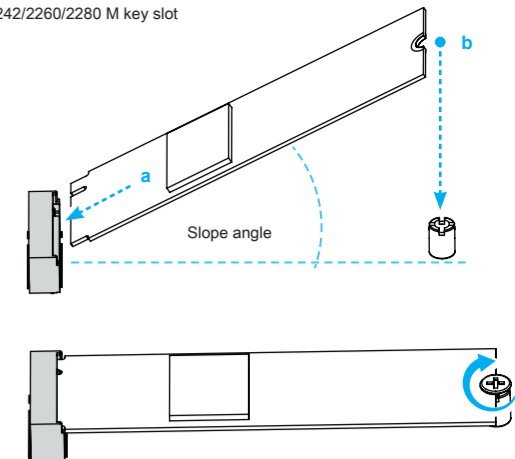
- 3. Check if the latches are closed and if all memory modules are firmly installed.
Repeat the above steps to install additional memory modules, if required.

D. M.2 Device Installation

- 1. Locate the M.2 key slots on the motherboard.
2. Install the M.2 device into the M.2 slot and secure with a screw.

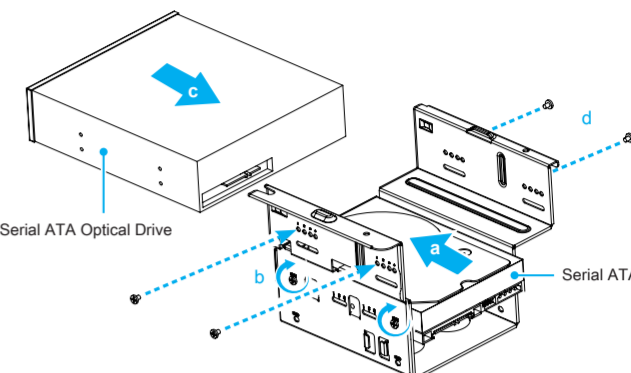


M.2 2242/2260/2280 M key slot

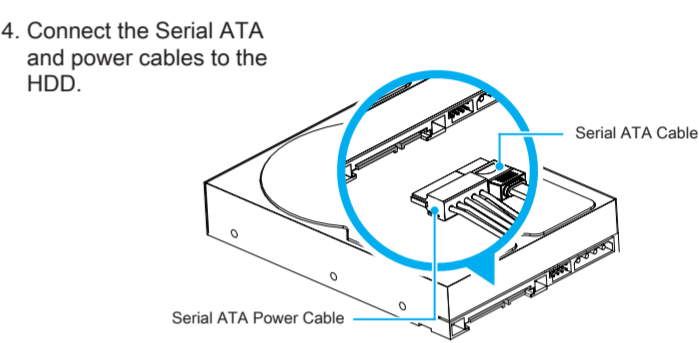


E. Installation of Drives

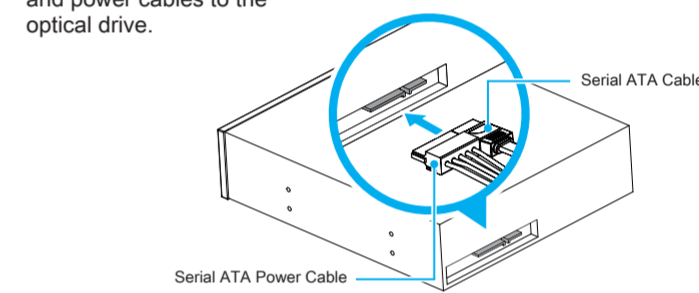
- 1. Loosen the purse lock and separate the Serial ATA and power cables.
2. Please place the HDD or SSD and the optical drive in the rack and secure with screws from the sides.



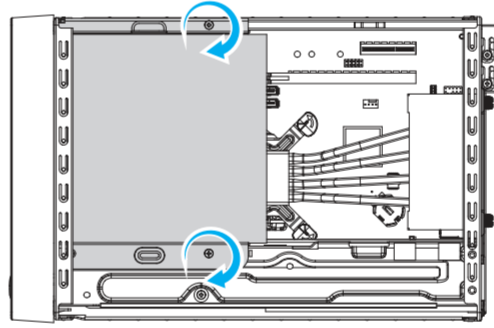
- 3. Connect the Serial ATA cable to the motherboard.



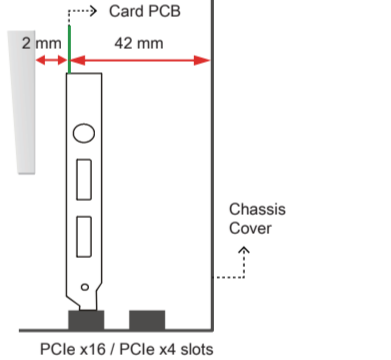
- 4. Connect the Serial ATA and power cables to the optical drive.



6. Place the rack in the chassis and refasten the rack.



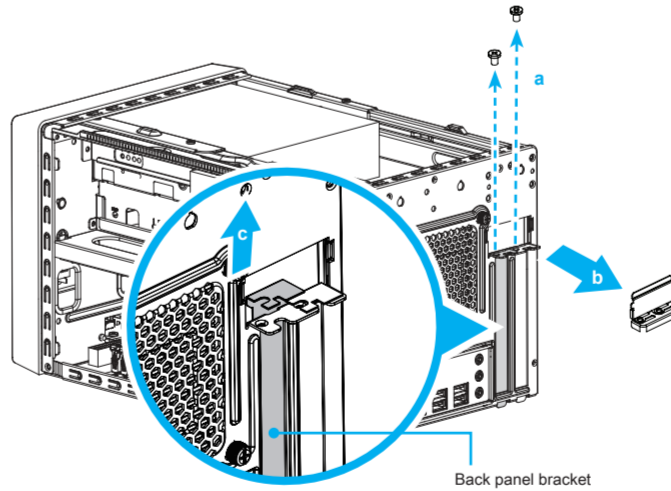
- 2. Install the PCIe x4 / PCIe x16 card into the PCIe x4 / PCIe x16 slots.
3. Secure the bracket.



F. Installation of Expansion Cards

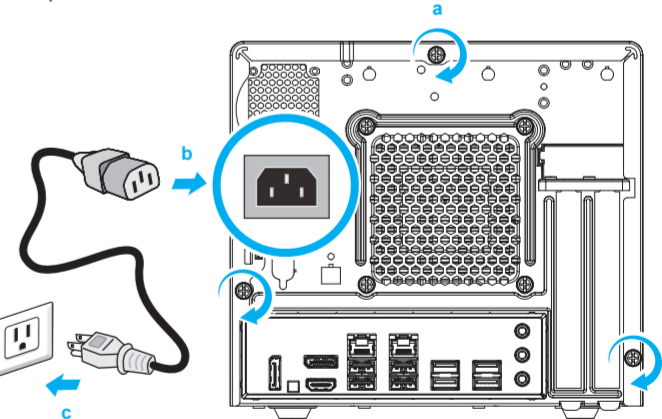
- 1. Unfasten the expansion slot bracket screws. Remove the back panel bracket and put it aside.

The maximum size acceptable for display cards is 273 mm (L) x 98 mm (H) x 38 mm (D).



G. Complete

- 1. Replace the cover and tighten the thumbscrews, then connect the power cord.
2. Complete.



Please press the "Del" key while booting to enter BIOS. Here, please load the optimised BIOS settings.

Safety Information

安全資訊 \ Sicherheitshinweise \ Informations de sécurité \ Información de seguridad \ 安全に関する情報 \ Информация о безопасности \ 安全信息

Incorrectly replacing the battery may damage this computer. Replace only with the same or equivalent as recommended by Shuttle. Dispose of used batteries according to the manufacturer's instructions.

更換電池方式錯誤可能會損壞本電腦以及引發爆炸、火災或其他危險。僅能依 Shuttle 的建議, 以相同或同等的電池更換。請依照製造商的使用說明處理廢電池。
Das unkorrekte Austauschen der Batterie kann diesen Computer beschädigen. Ersetzen Sie die Batterie nur durch den von Shuttle empfohlenen Typ oder ein gleichwertiges Modell. Entsorgen Sie gebrauchte Batterien gemäß den Herstellerangaben.
Ne pas remplacer correctement la pile peut endommager l'ordinateur. Remplacez-la uniquement par un modèle identique ou un équivalent comme recommandé par Shuttle. Débarrassez-vous des piles usagées d'après les instructions du constructeur.

La sustitución incorrecta de la batería puede dañar este equipo. Sustituya la batería únicamente por una igual o equivalente recomendada por Shuttle. Deseche las baterías usadas según las instrucciones del fabricante.

バッテリーを間違えてセットすると、このコンピュータが損傷する原因となります。交換する際は、Shuttle が推奨するバッテリーと同じものまたは同等のもののみを使用するようにしてください。使用済みバッテリーは、メーカーの指示に従って処分してください。

Неправильная замена батареи может привести к повреждению компьютера. Батарея должна соответствовать стандарту производителя Shuttle или быть идентичной предыдущей. Утилизация использованной батареи должна следовать инструкции производителя.
更換電池方式錯誤可能會損壞本電腦。僅能依 Shuttle 的建議, 以相同或同等的電池更換。請依照製造商的使用說明處理廢電池。

Laser compliance statement: The optical disc drive in this PC is a laser product. The drive's classification label is located on the drive. CLASS 1 LASER PRODUCT CAUTION: INVISIBLE LASER RADIATION WHEN OPEN. AVOID EXPOSURE TO BEAM.

雷射符合性聲明: 本主機中的光碟機屬於雷射產品。光碟機的等級標籤黏貼於光碟機上。BEIM OFFNEHEN DES GERÄTES AUSSTREITEN VERMEIDEN SIE ES, DEN STRAHLEN AUSGESETZT ZU WERDEN.
Laserkonformitätserklärung: Das optische Laufwerk in diesem PC ist ein Lasergerät. Auf dem Gerät ist ein Aufkleber mit der Klassifikation des Laufwerks zu finden. LASERKLASSE 1: PRODUKT ACHTUNG: UNSICHTBARE LASERSTRAHLUNG KANN BEIM OFFNEHEN DES GERÄTES AUSSTREITEN VERMEIDEN SIE ES, DEN STRAHLEN AUSGESETZT ZU WERDEN.

レーザ準拠声明: このサーバーの光ディスクドライブは、レーザ製品です。ドライブの分類レベルは、ドライブに貼ってあります。クラス1レーザ製品 注意: 開けると目に見えないレーザー照射にさらされます。ビームの暴露を避けてください。

Декларация соответствия лазера: Оптический привод на этом ПК представляет собой лазерный продукт. Маркировка диска находится на диске. ЛАЗЕРНЫЙ ПРОДУКТ КЛАССА 1 ПРЕДУПРЕЖДЕНИЕ: НЕВИДИМОЕ ЛАЗЕРНОЕ ИЗЛУЧЕНИЕ. КОГДА ОТКРЫТО. Избегайте воздействия радиации.

雷射符合性聲明: 本主機中的光碟機屬於雷射產品。光碟機的等級標籤黏貼於光碟機上。CLASS 1 雷射產品 注意: 打開時會有不可見的雷射光放射, 避免曝露於雷射光下。

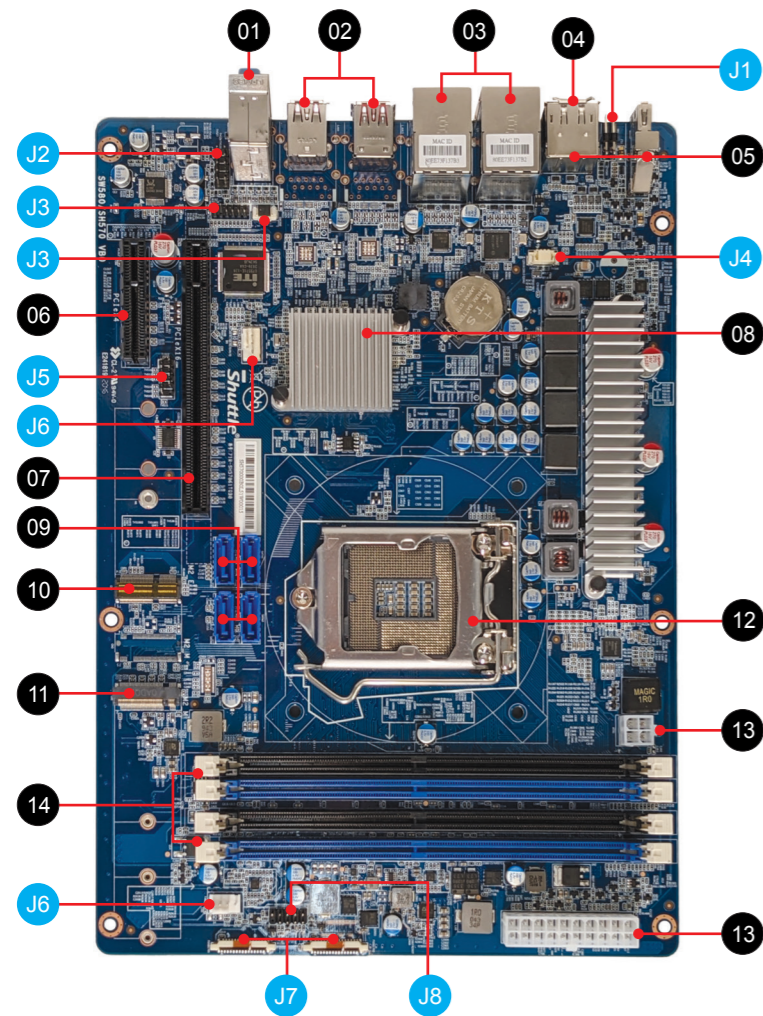
Etat de conformité du laser: Le lecteur de disque optique dans ce PC est un produit à laser. Le label de classification du lecteur laser est situé sur le lecteur. PRODUIT LASER DE CLASSE 1 ATTENTION: RADIATIONS LASER A L'OUVERTURE. EVITER L'EXPOSITION AU FAISCEAU LASER.

注意: 仅适用于在非热带气候条件下安全使用, 在热带气候条件下使用时, 可能有安全隐患。
注意: 仅适用于海拔 2000m 以下安全使用, 在海拔 2000m 以上使用时, 可能有安全隐患。
注意: 允许产品使用的最高环境温度为 40°C。
注意: 用错误型号电池更换会有爆炸危险, 务必按照说明处用充的电池。

Declaración de cumplimiento relacionada con el láser: La unidad de disco óptica de este servidor es un producto láser. La etiqueta de clasificación de la unidad se encuentra situada en dicha unidad. PRODUCTO LÁSER DE CLASE 1 PRECAUCIÓN: RADIACIÓN LASER INVISIBLE CUANDO SE ABRE. NO SE EXPONGA AL HAZ.

This device complies with Part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) this device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

This device meets the requirements for the CE conformity in accordance to the currently valid EU directives. Dieses Produkt erfüllt die Anforderungen für die CE-Konformität entsprechend der aktuell geltenden EU-Richtlinien. Ce produit répond aux exigences du marquage CE conformément aux directives européennes actuellement en vigueur. All bundled parts, power cord included, shall not be used without this product. 電源ケーブル等、すべての付属品は本機以外ではご使用になれません。



- 06. PCIe x4 slot
PCIe x4 插槽
PCIe x4 Steckplatz
Emplacement PCIe x4
PCIe x4 Ranura
PCIe x4 スロット
Слоты PCIe x4
PCIe x4 插槽
- 07. PCIe x16 slot
PCIe x16 插槽
PCIe x16 Steckplatz
Emplacement PCIe x16
PCIe x16 Ranura
PCIe x16 スロット
Слоты PCIe x16
PCIe x16 插槽

- 08. Intel® H570 chipset
Intel® H570 晶片組
Intel® H570 Chipsatz
Chipset Intel® H570
Intel® H570 Conjunto de chips
Intel® H570 チップセット
Набор микросхем Intel® H570
Intel® H570 芯片組

- 09. SATA 3.0 6Gb/s connector
SATA 3.0 6Gb/s 插槽
SATA 3.0-Anschlüsse (6 Gb/s)
Connecteurs SATA 3.0 6Gb/s
Base de conexiones SATA 3.0 6Gb/s
SATA 3.0 6Gb/s コネクタ
Разъем SATA 3.0 6 Гбит/с
SATA 3.0 6Gb/s 接口

- 10. M.2 2230 E key slot
M.2 2230 E key 插槽
M.2-2230 (E) Steckplatz
Emplacement M.2 2230 E
Ranura M.2 2230 E
M.2 2230 E キー-スロット
Слот M.2 2230 E ключ
M.2 2230 E key 插槽

- 11. M.2 2242/2260/2280 M key slot
M.2 2242/2260/2280 M key 插槽
M.2-2242/2260/2280 (M) Steckplatz
Emplacement M.2 2242/2260/2280 M
Ranura M.2 2242/2260/2280 M
M.2 2242/2260/2280 M キー-スロット
Слот M.2 2242/2260/2280 M ключ
M.2 2242/2260/2280 M key 插槽

- 12. Processor socket LGA 1200
LGA 1200 處理器插槽
Socket für LGA 1200-CPU's
Socket Processeur LGA 1200
Zócalo LGA 1200 de CPU
Процессор-socket LGA 1200
Разъем процессора LGA 1200
LGA 1200 处理器插座

- 13. ATX power connector
電源連接埠
ATX-Netzteil-Anschluss
Prise d'alimentation ATX
Conector de alimentación ATX
ATX電源コネクタ
ATX 電源コネクタ
ATX 電源插座

- 14. 4x 288-pin DDR4 DIMM slot
4x 288-pin DDR4 DIMM 插槽
4x 288-pin DDR4 DIMM Steckplatz
4x emplacements 288-pin pour DDR4 DIMM
4 ranuras DIMM DDR4 de 288 contactos Slots
4x 288-pin DDR4 DIMM スロット
4x 288 контактный Слот DDR4 DIMM
4x 288-pin DDR4 DIMM 插槽

- 01. Line-in port
音源輸入埠
Audio Line-In Eingang
Port d'entrée ligne
Entrada de audio Line-in
ラインインポート
Линейный вход
音源輸入端口

- Front speaker out (L/R) port
左 / 右声道輸出埠
Lautsprecher-Anschluss/Line-Out
Sortie audio avant (G/D)
Salida de audio Line-out
正面アウト (L/R) ポート
Линейный выход
左 / 右声道輸出端口

- Microphone jack
麥克風輸入埠
Mikrofon-Anschluss
Entrée Micro
Entrada del micrófono
マイクインポート
Гнездо для микрофона
麦克风连接端口

- 02. USB 3.2 Gen2 Type-A Ports
USB 3.2 Gen2 Type-A 連接埠
USB 3.2 Gen2 Typ-A-Anschlüsse
Prises USB 3.2 Gen2 Type-A
Puertos USB 3.2 Gen2 tipo A
USB 3.2 Gen2 Type-A ポート
USB 3.2 Gen2 Type-A 端口
USB 3.2 Gen2 Type-A 端口

- 03. LAN ports
網路連接埠
Netzwerk-Anschlüsse
Prises LAN
Puertos LAN
LAN 端口
Сетевые LAN-порты
LAN 连接端口

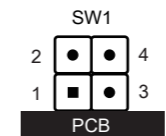
- 03. USB 2.0 ports
USB 2.0 連接埠
USB 2.0-Anschlüsse
Prises USB 2.0
Puertos USB 2.0
USB 2.0 ポート
USB 2.0 端口
USB 2.0 连接端口

- 04. HDMI 2.0 port
HDMI 2.0 連接埠
HDMI 2.0-Anschluss
Prise HDMI 2.0
Puerto HDMI 2.0
HDMI 2.0 ポート
HDMI 2.0 端口
HDMI 2.0 连接埠

- 05. DisplayPort
DisplayPort 連接埠
DisplayPort
Prise DisplayPort
DisplayPort
ディスプレイポート
DisplayPort
DisplayPort 连接埠

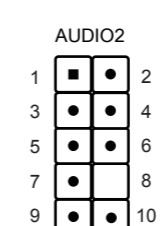
- J1 Clear CMOS & power button & +5V
清除 CMOS & 電源按鈕 & +5V
Clear CMOS & Power Button & +5V
Reset CMOS & Bouton d'alimentation & +5V
Clear CMOS & Botón de encendido & +5V
CMOSクリア & 電源スイッチ & +5V
Сброс CMOS, внешняя кнопка питания, +5 В
清除 CMOS & 電源按鈕 & +5V

- 1=RTC Reset
2=VCC_AUX (Power source 5.0V/0.5A)(Disable in Eup mode)
3=GND
4=Power SW



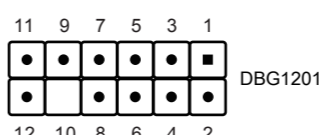
- J2 Front audio header
前面板音效插座
Audio-Anschluss für Vorderseite
Connecteur audio pour façade
Conector de audio del panel frontal
前面オーディオヘッド
Передний аудио разъем
前面板音效插座

- 1=Microphone input L
2=Audio GND
3=Microphone input R
4=Front panel daughter board detection (Low active)
5=Headphone out R
6=Microphone audio jack detect
7=Front panel audio jack sense
8=NULL
9=Headphone out L
10=Headphone audio jack detect



- J3 Debug header
Debug 插座
Debug-Anschluss
Connecteur Debug
Conexión Debug
デバッグヘッド
Отладочный разъем
Debug 接头

- 1=I2C Data for EC debug
2=I2C Clock for EC debug



- 1=eSPI clock signal
2=eSPI IO_1 signal
3=PCIe platform reset
4=eSPI IO_0 signal
5=eSPI chip select signal (Low active)
6=3VSB (Power source 3.0V)
7=eSPI IO_3 signal
8=GND (Power Ground)
9=eSPI IO_2 signal
10=NULL
11=eSPI alert signal (Low active)
12=eSPI reset signal (Low active)

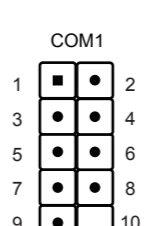
- J4 USB 2.0 cable connector
USB 2.0 排線插座
Anschluss für USB 2.0-Kabel
Connecteur câble USB 2.0
Conexión para cable USB 2.0
USB 2.0ケーブルコネクタ
Разъем USB 2.0-кабеля
USB 2.0扁平电缆插座

- 1=GND (Power Ground)
2=Data+ (USB 2.0 Data pin)
3=Data- (USB 2.0 Data pin)
4=VBUS (USB power 5.0V/0.5A)



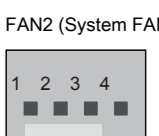
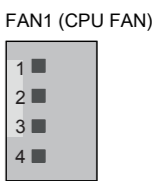
- J5 COM header
COM 插座
COM-Anschluss
Connecteur COM
Base de conexiones COM
COM コネクタ
Разъем COM
COM 插座

- 1=DCD
2=RXD
3=TXD
4=DTR
5=GND
6=DSR
7=RTS
8=CTS
9=-XRI1
10=NULL



- J6 Fan connector
風扇連接埠
Lüfteranschluss
Connecteur ventilateur
Conector del ventilador
FAN コネクタ
Разъем вентилятора
风扇插座

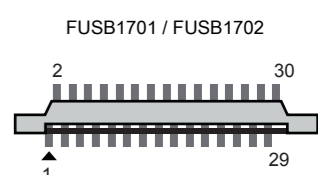
- 1=GND
2=+12V
3=FAN IO
4=FAN PWM



- J7 Front USB 3.0 header
前置 USB 3.0 插座
USB-3.0-Anschluss (für vorne)
Port USB 3.0 (façade)
Conexión delantera USB 3.0
フロントUSB 3.0 用ピンヘッド
Разъем USB 3.0 порта (передняя панель)
前置 USB 3.0 插座

- 1=3VSB (Power source 3.3V)
2=5V_DAU (Power Source 5.0V)
3=5V_DAU (Power Source 5.0V)
4=5V_DAU (Power Source 5.0V)
5=USB Power ON (Low active)
6=GND
7=USB3.2 Gen1 port 1 RX_N
8=USB3.2 Gen1 port 1 RX_P
9=GND
10=USB3.2 Gen1 port 1 TX_N
11=USB3.2 Gen1 port 1 TX_P
12=GND

- 13=USB2.0 Port 1 Data N
14=USB2.0 Port 1 Data P
15=GND
16=GND
17=USB2.0 Port 2 Data P
18=USB2.0 Port 2 Data N
19=GND
20=USB3.2 Gen1 port 2 TX_P
21=USB3.2 Gen1 port 2 TX_N
22=GND
23=USB3.2 Gen1 port 2 RX_P
24=USB3.2 Gen1 port 2 RX_N
25=GND
26=USB Power ON (Low active)
27=5V_DAU (Power Source 5.0V)
28=5V_DAU (Power Source 5.0V)
29=5V_DAU (Power Source 5.0V)
30=3VSB (Power source 3.3V)



- J8 Connector for front buttons/LEDs
電源按鈕/LED插座
Anschluss für vordere Buttons/LEDs
Connexion pour les boutons en façade
Conexión para pulsadores frontales/LEDs
フロントボタンLED用コネクタ
Разъем для кнопок / LED-индикаторов передней панели
電源按鈕/LED插座

- 1=HDD LED P
2=Power LED P
3=HDD LED N
4=Power LED N
5=System reset (Low active)
6=Power switch (Low active)
7=GND
8=GND
9=NA
10=NULL

